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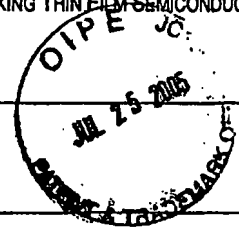
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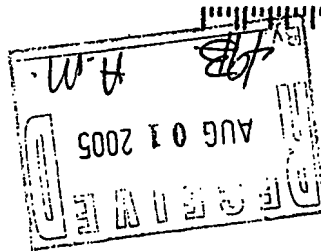
Patent Office Mail Room: Please affix the Patent Office stamp and return this card to acknowledge receipt of the following documents:

Docket No.: 09792909-3402
Client: SONY CORPORATION
1st Inventor: TAYANAKA, Hiroshi
Title of Invention: THIN FILM SEMICONDUCTOR AND METHOD FOR MAKING THIN FILM SEMICONDUCTOR
U.S. Patent No: 6,326,280
Filed Date: Herewith

1. Disclaimer in Patent Under 37 CFR 1.321(a) (1 page);
2. Credit Card Payment Form (1 pg); and,
2. Post card receipt (1).

Drafted By: David R. MetzgerMailed By: Suzarah Maquigad

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